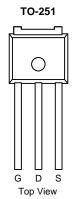
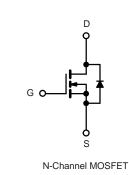


# N-Channel 200 V (D-S) MOSFET

PRODUCT	SUMMARY	
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
200	0.270 at V <sub>GS</sub> = 10 V	8





#### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

• Primary Side Switch

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	200	v	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T. 175 °C)	T <sub>C</sub> = 25 °C T <sub>C</sub> = 125 °C		8	_	
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^{b}$	T <sub>C</sub> = 125 °C	I <sub>D</sub>	5		
Pulsed Drain Current		I <sub>DM</sub>	25	A	
Continuous Source Current (Diode Conduction)	۱ <sub>S</sub>	5			
Avalanche Current	I <sub>AS</sub>	5			
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	18	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	96 <sup>b</sup>	w	
	T <sub>A</sub> = 25 °C	0	3 <sup>a</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 10 s	R <sub>thJA</sub>	15	18	
Junction-to-Ambient <sup>a</sup>	Steady State		40	50	°C/W
Junction-to-Case (Drain)		R <sub>thJC</sub>	0.85	1.1	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.





Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$			50	μA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$			250		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	40			Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		0.270			
	в	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		0.300		Ω	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$		0.320			
		$V_{GS} = 6 V, I_D = 3 A$		0.310			
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 3 A		35		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			800		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 25 V, F = 1 MHz		100			
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
Total Gate Charge <sup>c</sup>	Qg			34	51		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 10 V, $I_D$ = 3 A		8			
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			12			
Gate Resistance	R <sub>g</sub>		0.5		2.9	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25		
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 100 V, R <sub>L</sub> = 5.2 $\Omega$		50	75	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ 3 A, $V_{GEN}$ = 10 V, $R_g$ = 2.5 $\Omega$		30	45		
Fall Time <sup>c</sup>	t <sub>f</sub>			60	90		
Source-Drain Diode Ratings and Char	acteristics (1	Γ <sub>C</sub> = 25 °C)					
Pulsed Current	I <sub>SM</sub>				5	А	
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = 3 A, V <sub>GS</sub> = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 3 A, dl/dt = 100 A/μs		180	250	ns	

Notes:

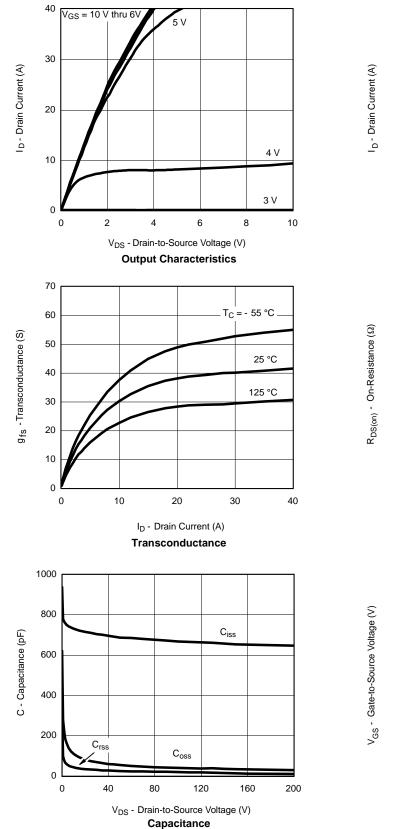
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

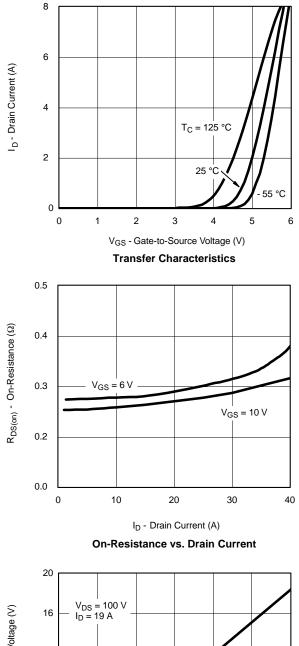
c. Independent of operating temperature.

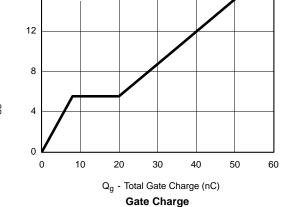
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







1.2

10 µs

T T H 100 µs

ms

<u>++++t</u>

1000

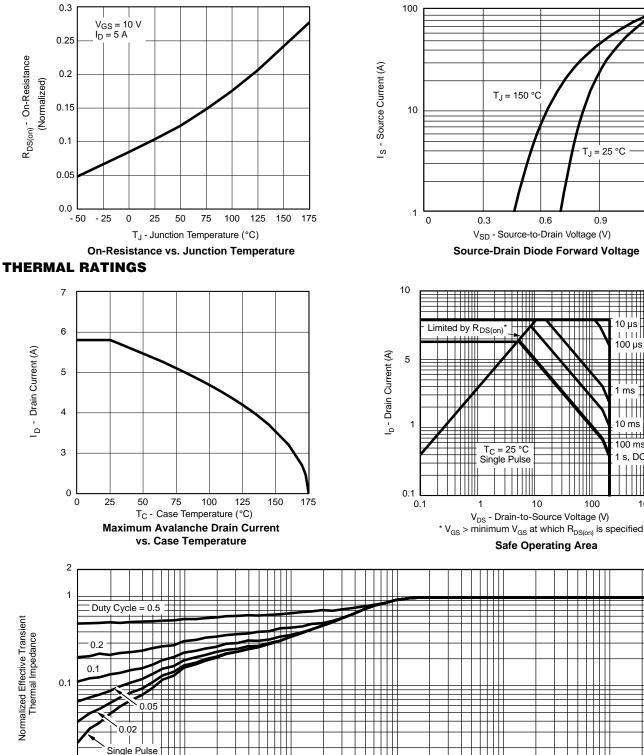
100 ms

1 s, DC 1111

10

30





Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

10<sup>-1</sup>

1

10-2

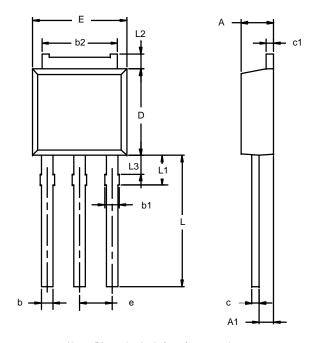
10<sup>-3</sup>

0.01 10-4

### **VBFB1203M**



### **TO-251AA**



Min	Max	Min	Max
2.21	2.38	0.087	0.094
0.89	1.14	0.035	0.045
0.71	0.89	0.028	0.035
0.76	1.14	0.030	0.045
5.23	5.43	0.206	0.214
0.46	0.58	0.018	0.023
0.46	0.58	0.018	0.023
5.97	6.22	0.235	0.245
6.48	6.73	0.255	0.265
2.28	BSC	0.090	BSC
3.89	9.53	0.153	0.375
1.91	2.28	0.075	0.090
0.89	1.27	0.035	0.050
1.15	1.52	0.045	0.060
	0.89 0.71 0.76 5.23 0.46 0.46 5.97 6.48 2.28 3.89 1.91 0.89 1.15	1.14   0.89 1.14   0.71 0.89   0.76 1.14   5.23 5.43   0.46 0.58   0.46 0.58   5.97 6.22   6.48 6.73   2.28 BSC 3.89   9.53 1.91   2.28 0.89	1.11 1.14 0.035   0.89 1.14 0.035   0.71 0.89 0.028   0.76 1.14 0.030   5.23 5.43 0.206   0.46 0.58 0.018   0.46 0.58 0.018   5.97 6.22 0.235   6.48 6.73 0.255   2.28 BSC 0.090   3.89 9.53 0.153   1.91 2.28 0.075   0.89 1.27 0.035   1.15 1.52 0.045

Note: Dimension L3 is for reference only.

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